

Appl. No. 09/926,758
Amdt. Dated June 1, 2004
Reply to Office Action of April 21, 2004

Amendments to the Specification:

Please replace the paragraph beginning at page 10, line 13, with the following amended paragraph:

The annealing is preferably effected at 150 to 200 °C ~~as set forth in Claim 4~~, when the balance between conductivity and strength is of special concern, because the plate tends to decrease in strength relatively significantly when annealed at 200 °C or more.